

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6969981

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
LISA SCHMIDT	11/15/2019
TODD MCDONALD	11/15/2019
SAVITA JENSEN	11/15/2019
JOSEPH GEORGE AKAMITTATH	11/21/2019
ALAN D. HAHN	11/15/2019
ANTHONY J CLARK	11/15/2019
BHUPENDRA KUMAR SONI	11/19/2019
JAMES PATRICK LANGAN	11/19/2019
BROOKS JOHN KELLY	11/19/2019
HUNTINGTON DAVIS	11/15/2019
RECEIVING PARTY DATA	
Name:	MYCOTECHNOLOGY, INC.
Street Address:	18250 E. 40TH, SUITE 50
City:	AURORA
State/Country:	COLORADO
Postal Code:	80011
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17501736
CORRESPONDENCE DATA	
Fax Number:	(312)616-5700
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	(720) 795-7976
Email:	tcrispino@leydig.com, assignments@leydig.com
Correspondent Name:	MICHAEL J. CURTIS
Address Line 1:	4940 PEARL EAST CIRCLE, SUITE 200
Address Line 4:	BOULDER, COLORADO 80301
ATTORNEY DOCKET NUMBER:	339023: 0640.29 US2

NAME OF SUBMITTER:	MICHAEL J. CURTIS
SIGNATURE:	/michaelcurtisREG54053/
DATE SIGNED:	10/14/2021
Total Attachments: 10 source=Assignment_exd#page1.tif source=Assignment_exd#page2.tif source=Assignment_exd#page3.tif source=Assignment_exd#page4.tif source=Assignment_exd#page5.tif source=Assignment_exd#page6.tif source=Assignment_exd#page7.tif source=Assignment_exd#page8.tif source=Assignment_exd#page9.tif source=Assignment_exd#page10.tif	

ASSIGNMENT

WHEREAS, I/WE:

1. **Assignor:** Lisa SCHMIDT, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
2. **Assignor:** Todd MCDONALD, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
3. **Assignor:** Savita JENSEN, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
4. **Assignor:** Joseph George AKAMITTATH, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
5. **Assignor:** Alan D. HAHN, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
6. **Assignor:** Anthony J. CLARK, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
7. **Assignor:** Bhupendra Kumar SONI, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
8. **Assignor:** James Patrick LANGAN, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
9. **Assignor:** Brooks John KELLY, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
10. **Assignor:** Huntington DAVIS, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;

herein called individually an "ASSIGNOR" and collectively "ASSIGNORS," in connection with the invention entitled:

"MYCELIATED VEGETABLE PROTEIN AND FOOD COMPOSITIONS COMPRISING SAME"

for which the following patent application(s):

Country Code	Application Serial No.	Filing Date
US	16/666,936	October 29, 2019

was/were submitted or filed (collectively, the "LISTED APPLICATION(S)");

AND WHEREAS, Assignee: MycoTechnology, Inc.

(herein called "ASSIGNEE"), an entity organized and existing under the laws of the State of Delaware, having a principal place of business at:

**18250 E. 40th, Suite 50
Aurora, CO 80011
United States of America**

is desirous of obtaining my/our entire right, title and interest in, to and under the said invention and the said LISTED APPLICATION(S);

**LVM Docket No. 337592: 0640.29 US
Assignment**

NOW, THEREFORE, in consideration of my contractual and other legal obligations, and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, a said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the invention(s) and discoveries disclosed in the LISTED APPLICATION(S), and the LISTED APPLICATION(S) and all divisions, renewals, continuations and subsequent applications thereof, and all Patents of the United States which may be granted thereon and all reissues, reexaminations, and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention(s) and discoveries in any country or countries foreign to the United States; together with the right to file such applications and the right to claim for the same the benefit of priority of said inventions, discoveries, and patent applications listed herein, including the LISTED APPLICATION(S) and applications thereof and therefrom under The International Union for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application and applications thereof and therefrom is/are filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention(s) in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and any and all claims, causes of action, and damages for past, present, and future infringement or other unauthorized use of the above items, along with the right to sue for and to collect damages and other relief;

AND I HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States, and any official of any country or countries foreign to the United States whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND I HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

AND I HEREBY authorize the above-mentioned ASSIGNEE or its legal representative to insert in this instrument the filing date and serial number of said application(s) or any other information that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document;

AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention(s) and discoveries, and testify in any legal proceeding, sign all lawful papers, execute all continuing and subsequent applications, including divisional, reissue and foreign applications, make all rightful oaths, and generally cooperate and do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain, maintain, and enforce proper protection for said invention(s) and discoveries in any and all countries;

AND I HEREBY further agree that this Assignment does not create any agency, employment, or partnership relationship between the parties;

LVM Docket No. 337592: 0640.29 US
Assignment

AND I HEREBY further agree that this Assignment shall not be construed against any party on the ground that such party was responsible for the preparation of this Assignment, or on any related ground;

AND I HEREBY further agree that should any provision of this Assignment be determined to be void, unenforceable, or against public policy, such provision may altered in time or scope in order to give effect to such provision. If such alternation is not possible, such provision shall be deemed severed from this Assignment and the balance of this Assignment shall remain in full force and effect, so long as the original intent of this Assignment remains substantially intact.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal (if applicable) the day and year set opposite my signature.

Assignor 1: Lisa SCHMIDT

11-15-19 (sign) Lisa Schmidt
Date

Assignor 2: Todd MCDONALD

11/15/19 (sign) Todd McDonald
Date

Assignor 3: Savita JENSEN

Nov. 15, 2019 (sign) Savita Jensen
Date

Assignor 4: Joseph George AKAMITTATH

____ (sign) _____
Date


Assignor 5: Alan D. HAHN

11/15/2019 (sign) Alan D. Hahn
Date


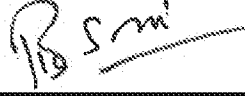
Additional Assignors on additional sheets: Yes

LVM Docket No. 337592: 0640.29 US
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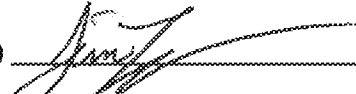
Assignor 6: Anthony J. CLARK

11/15/19 (sign) 
Date

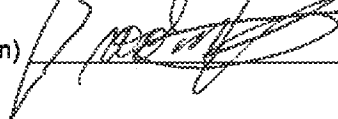
Assignor 7: Bhupendra Kumar SONI

 11/19/2019 (sign) 
Date

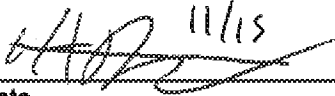
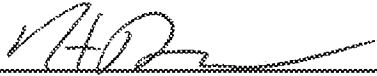
Assignor 8: James Patrick LANGAN

11/19/2019 (sign) 
Date

Assignor 9: Brooks John KELLY

11.19.19 (sign) 
Date

Assignor 10: Huntington DAVIS

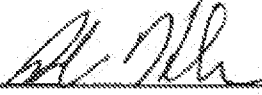
 11/15 (sign) 
Date

Additional Assignors on additional sheets: No

LVM Docket No. 337592: 0640.29 US
Assignment

Assignee: MycoTechnology, Inc.

11/15/2019
Date

(sign) 
(print full name) Alan Hahn
(title) CEO

ASSIGNMENT

WHEREAS, I/WE:

1. **Assignor: Lisa SCHMIDT**, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
2. **Assignor: Todd MCDONALD**, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
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4. **Assignor: Joseph George AKAMITTATH**, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
5. **Assignor: Alan D. HAHN**, available at 18250 E. 40th, Suite 50, Aurora, CO 80011 USA;
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Aurora, CO 80011
United States of America**

is desirous of obtaining my/our entire right, title and interest in, to and under the said invention and the said LISTED APPLICATION(S);

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NOW, THEREFORE, in consideration of my contractual and other legal obligations, and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, a said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the invention(s) and discoveries disclosed in the LISTED APPLICATION(S), and the LISTED APPLICATION(S) and all divisions, renewals, continuations and subsequent applications thereof, and all Patents of the United States which may be granted thereon and all reissues, reexaminations, and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention(s) and discoveries in any country or countries foreign to the United States; together with the right to file such applications and the right to claim for the same the benefit of priority of said inventions, discoveries, and patent applications listed herein, including the LISTED APPLICATION(S) and applications thereof and therefrom under The International Union for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application and applications thereof and therefrom is/are filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention(s) in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and any and all claims, causes of action, and damages for past, present, and future infringement or other unauthorized use of the above items, along with the right to sue for and to collect damages and other relief;

AND I HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States, and any official of any country or countries foreign to the United States whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

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IN TESTIMONY WHEREOF, I hereunto set my hand and seal (if applicable) the day and year set opposite my signature.

Assignor 1: Lisa SCHMIDT

Date (sign) _____

Assignor 2: Todd MCDONALD

Date (sign) _____

Assignor 3: Savita JENSEN

Date (sign) _____

Assignor 4: Joseph George AKAMITTATH

11-21-19
Date (sign) 

Assignor 5: Alan D. HAHN

Date (sign) _____

Additional Assignors on additional sheets: Yes

LVM Docket No. 337592: 0640.29 US
Assignment

Assignor 6: Anthony J. CLARK

Date (sign) _____

Assignor 7: Bhupendra Kumar SONI

Date (sign) _____

Assignor 8: James Patrick LANGAN

Date (sign) _____

Assignor 9: Brooks John KELLY

Date (sign) _____

Assignor 10: Huntington DAVIS

Date (sign) _____

Additional Assignors on additional sheets: No

Assignee: MycoTechnology, Inc.

December 24, 2019 (sign) Mary Breen Smith
Date (print full name) Mary Breen Smith
(title) Corporate Intellectual Property
Counsel